Qualcomm

RF360
Europe GmbH

SAW components

SAW duplexer
Small cell & femtocell
LTE band 13

Series/type:	B8005
Ordering code:	B39781B8005P810
Date:	January 23, 2018
Version:	2.2

RF360 products mentioned within this document are products of RF360 Europe GmbH and other subsidiaries of RF360 Holdings Singapore Pte. Ltd. (collectively, the “RF360 Subsidiaries”).

RF360 Europe GmbH, Anzinger Str. 13, München, Germany

RF360 Europe GmbH

A Qualcomm – TDK Joint Venture

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RF360 Europe GmbH, Anzinger Str. 13, München, Germany

SAW components **B8005**

SAW duplexer **751 / 782 MHz**

Data sheet

Table of contents

1 Application

- Low-loss SAW duplexer for LTE small cell & femtocell systems (Band 13)
- Usable pass band 10 MHz
- Low insertion attenuation
- Low insertion ripple
- High power durability
- Rx = uplink = 777 – 787 MHz
- Tx = downlink = 746 – 756 MHz

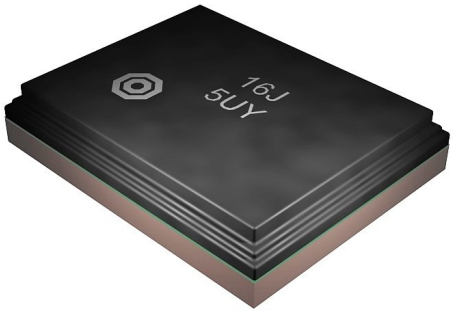

Figure 1: Picture of component with example of product marking.

2 Features

- Industrial grade qualified family
- Package size 2.5±0.1 mm × 2.0±0.1 mm
- Package height 0.5 mm (max.)
- Approximate weight 0.01 g
- RoHS compatible
- Package for Surface Mount Technology (SMT)
- Ni/Au-plated terminals
- Electrostatic Sensitive Device (ESD)
- Moisture Sensitivity Level 2a (MSL2a)

3 Package

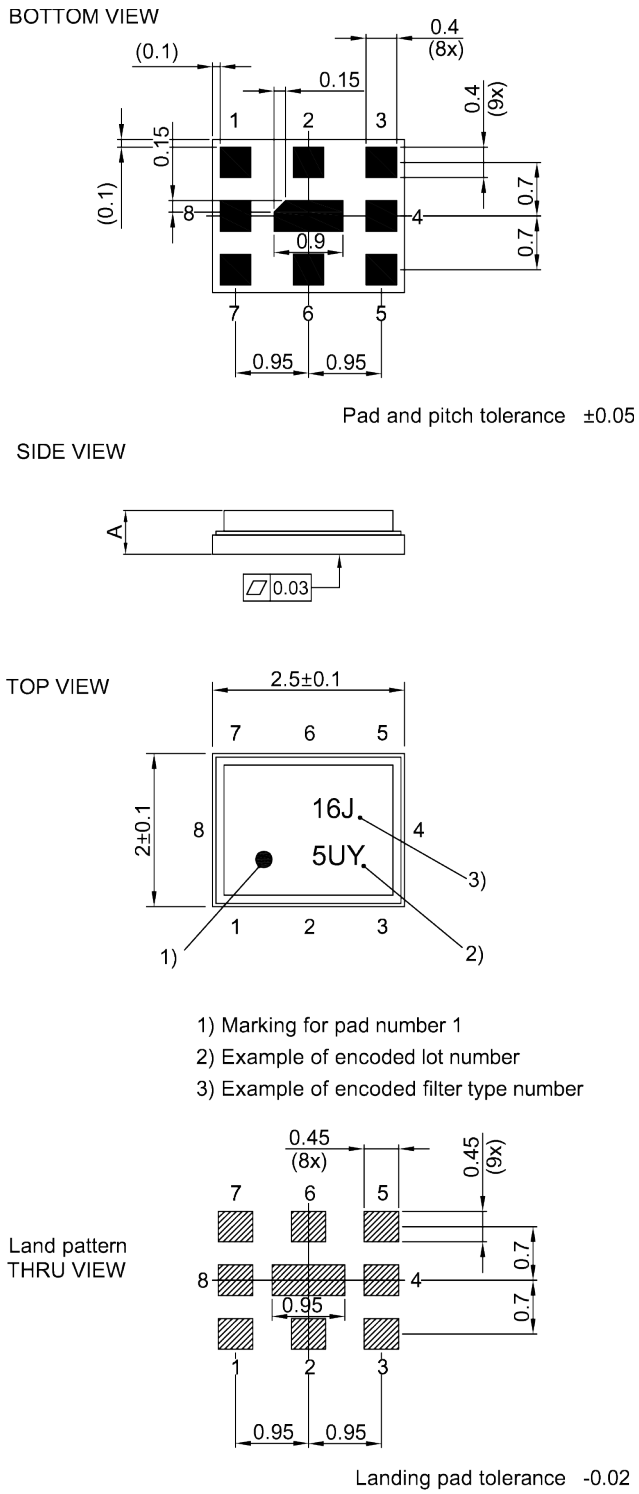

Figure 2: Drawing of package with package height A = 0.5 mm (max.). See Sec. Package information (p. 24).

4 Pin configuration

- 1 TX
- 3 RX
- 6 ANT
- 2, 4, 5, 7, 8, 9 Ground

5 Matching circuit

■ L_{p6} = 17 nH

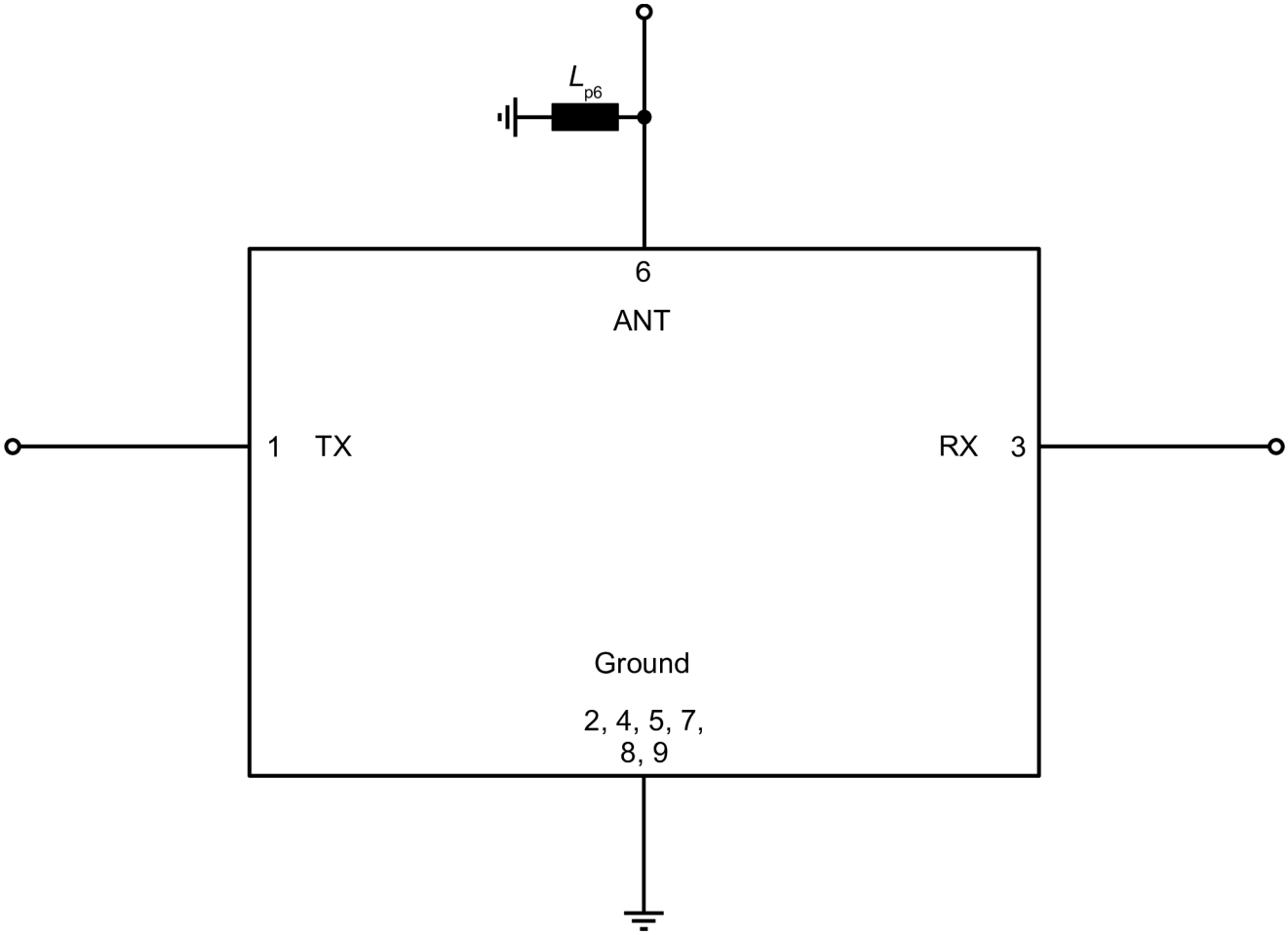

Figure 3: Schematic of matching circuit.

6 Characteristics

6.1 TX – ANT

Temperature range for specification T_{SPEC} = −10 °C ... +85 °C
TX terminating impedance Z_{TX} = 50 Ω
ANT terminating impedance Z_{ANT} = 50 Ω with par. 17 nH[1)]
RX terminating impedance Z_{RX} = 50 Ω

Characteristics TX – ANT				**min.** for T_{SPEC}	**typ.** @ +25 °C	**max.** for T_{SPEC}	
Center frequency			f_C	—	751	—	MHz
Maximum insertion attenuation			α_{max}				
	746 ... 756	MHz		—	1.6	2.0	dB
Amplitude ripple (p-p)			$\Delta\alpha$				
	746 ... 756	MHz		—	0.4	1.0	dB
Maximum VSWR			$VSWR_{max}$				
@ TX port	746 ... 756	MHz		—	1.5	1.8	
@ ANT port	746 ... 756	MHz		—	1.4	1.8	
Maximum error vector magnitude			EVM_{max} [2)]				
	748.5 ... 753.5	MHz		—	1.6	2.5	%
Minimum attenuation			α_{min}				
	10 ... 150	MHz		40	55	—	dB
	150 ... 350	MHz		35	45	—	dB
	350 ... 650	MHz		30	38	—	dB
	698 ... 716	MHz		35	38	—	dB
	716 ... 722	MHz		38	43	—	dB
	777 ... 787	MHz		54	58	—	dB
	788 ... 798	MHz		45	52	—	dB
	798 ... 849	MHz		35	43	—	dB
	1492 ... 1543	MHz		35	39	—	dB
	1554 ... 1574	MHz		35	39	—	dB
	1574 ... 1606	MHz		35	40	—	dB
	1710 ... 1770	MHz		35	40	—	dB
	1850 ... 1915	MHz		35	40	—	dB
	1920 ... 1980	MHz		35	40	—	dB
	2200 ... 2690	MHz		33	38	—	dB
	2690 ... 3800	MHz		25	43	—	dB
	5150 ... 5850	MHz		5	25	—	dB

1) See Sec. Matching circuit (p. 6).
2) Error Vector Magnitude (EVM) based on definition in 3GPP TS 25.141.

6.2 ANT – RX

Temperature range for specification	T_{SPEC}	= −10 °C ... +85 °C
TX terminating impedance	Z_{TX}	= 50 Ω
ANT terminating impedance	Z_{ANT}	= 50 Ω with par. 17 nH[1)]
RX terminating impedance	Z_{RX}	= 50 Ω

Characteristics ANT – RX				**min.** for T_{SPEC}	**typ.** @ +25 °C	**max.** for T_{SPEC}	
Center frequency			f_C	—	782	—	MHz
Maximum insertion attenuation			α_{max}				
	777 ... 787	MHz		—	1.9	2.5	dB
Amplitude ripple (p-p)			$\Delta\alpha$				
	777 ... 787	MHz		—	0.6	1.5	dB
Maximum VSWR			$VSWR_{max}$				
@ ANT port	777 ... 787	MHz		—	1.5	1.8	
@ RX port	777 ... 787	MHz		—	1.6	1.8	
Maximum error vector magnitude			EVM_{max} [2)]				
	779.5 ... 784.5	MHz		—	2.2	3.0	%
Minimum attenuation			α_{min}				
	10 ... 150	MHz		40	55	—	dB
	150 ... 350	MHz		35	45	—	dB
	350 ... 650	MHz		30	37	—	dB
	728 ... 746	MHz		35	50	—	dB
	746 ... 756	MHz		50	57	—	dB
	758 ... 768	MHz		28	30	—	dB
	808 ... 818	MHz		35	47	—	dB
	859 ... 894	MHz		35	45	—	dB
	1452 ... 1492	MHz		40	52	—	dB
	1554 ... 1574	MHz		40	52	—	dB
	1574 ... 1606	MHz		45	52	—	dB
	1670 ... 1675	MHz		40	50	—	dB
	1930 ... 1995	MHz		40	48	—	dB
	2110 ... 2170	MHz		40	49	—	dB
	2300 ... 2361	MHz		28	33	—	dB
	2361 ... 2690	MHz		30	42	—	dB
	3300 ... 3800	MHz		15	22	—	dB
	5150 ... 5850	MHz		5	12	—	dB

1) See Sec. Matching circuit (p. 6).
2) Error Vector Magnitude (EVM) based on definition in 3GPP TS 25.141.

6.3 TX – RX

Temperature range for specification	T_{SPEC}	= −10 °C ... +85 °C
TX terminating impedance	Z_{TX}	= 50 Ω
ANT terminating impedance	Z_{ANT}	= 50 Ω with par. 17 nH[1)]
RX terminating impedance	Z_{RX}	= 50 Ω

Characteristics TX – RX				**min.** for T_{SPEC}	**typ.** @ +25 °C	**max.** for T_{SPEC}	
Minimum isolation			α_{min}				
	746... 756	MHz		50	60	—	dB
	777... 787	MHz		52	58	—	dB

1) See Sec. Matching circuit (p. 6).

7 Maximum ratings

Operable temperature	T_{OP} = −40 °C ... +95 °C	
Storage temperature	T_{STG} [1] = −40 °C ... +95 °C	
DC voltage	$\|V_{DC}\|$ [2] = 0 V	
ESD voltage		
	V_{ESD} [3] = 50 V	Machine model.
	V_{ESD} [4] = 100 V	Human body model.
Input power	P_{IN}	
@ TX port: 746 ... 756 MHz	28 dBm[5]	5 MHz LTE downlink signal (25 RB) for 100000 h @ 55 °C. P_{IN} 28 dBm average – 39 dBm peak. Source and load impedance 50Ω.
@ TX port: other frequency ranges	10 dBm	Source and load impedance 50Ω.
Operating lifetime with output power at antenna 746 ... 756 MHz	P_{OUT} [6] = 24 dBm	Continuous wave for 100000 h @ 55 °C. Source and load impedance 50Ω.

1) Not valid for packaging material. Storage temperature for packaging material is −25 °C to +40 °C.
2) In case of applied DC voltage blocking capacitors are mandatory.
3) According to JESD22-A115B (MM – Machine Model), 10 negative & 10 positive pulses.
4) According to JESD22-A114F (HBM – Human Body Model), 1 negative & 1 positive pulse.
5) Expected lifetime according to power durability tests, and wear out models.
6) According to accelerated high temperature operating life (HTOL) test.

8 Transmission coefficients

8.1 TX – ANT

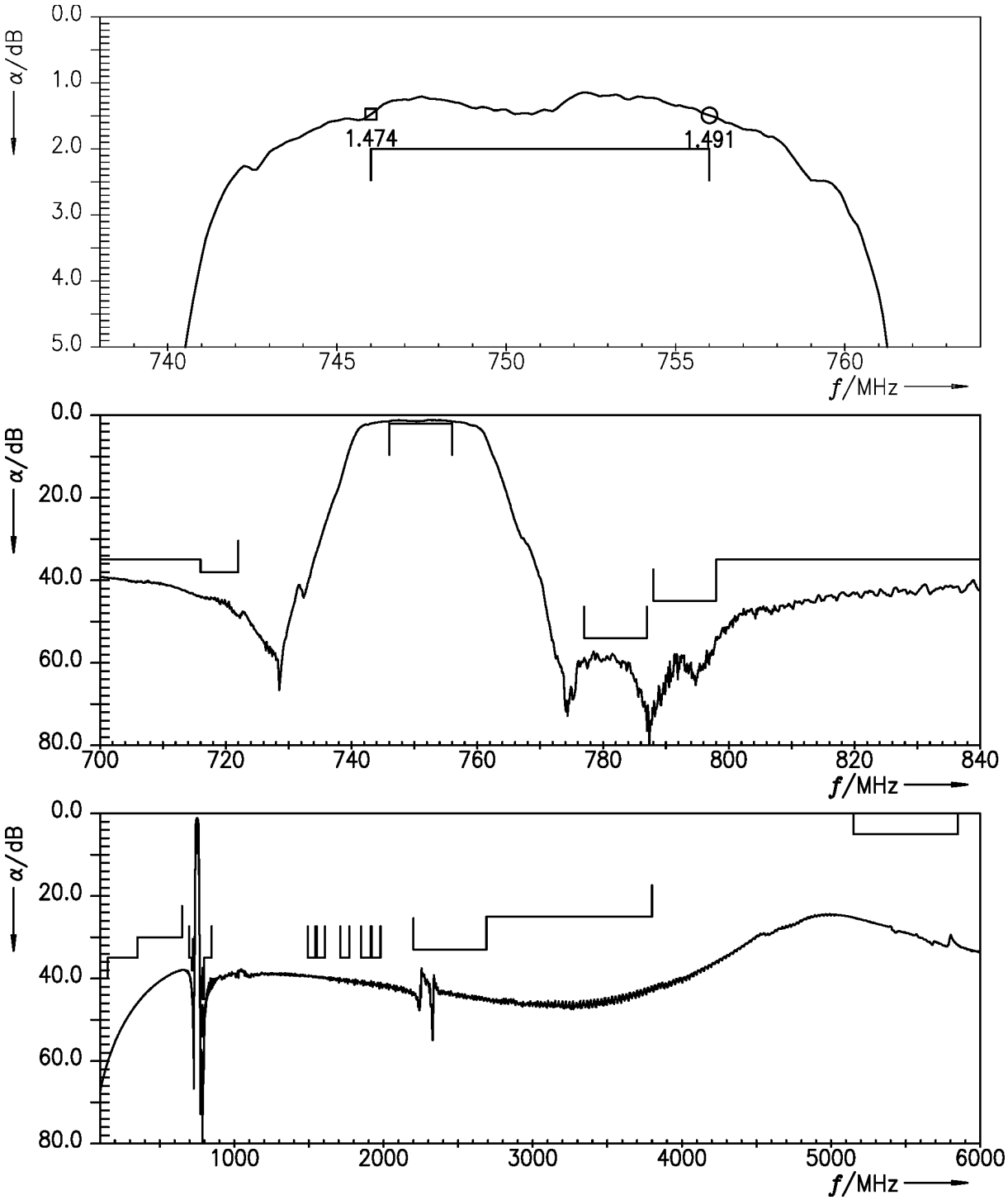

Figure 4: Attenuation TX – ANT.

8.2 ANT – RX

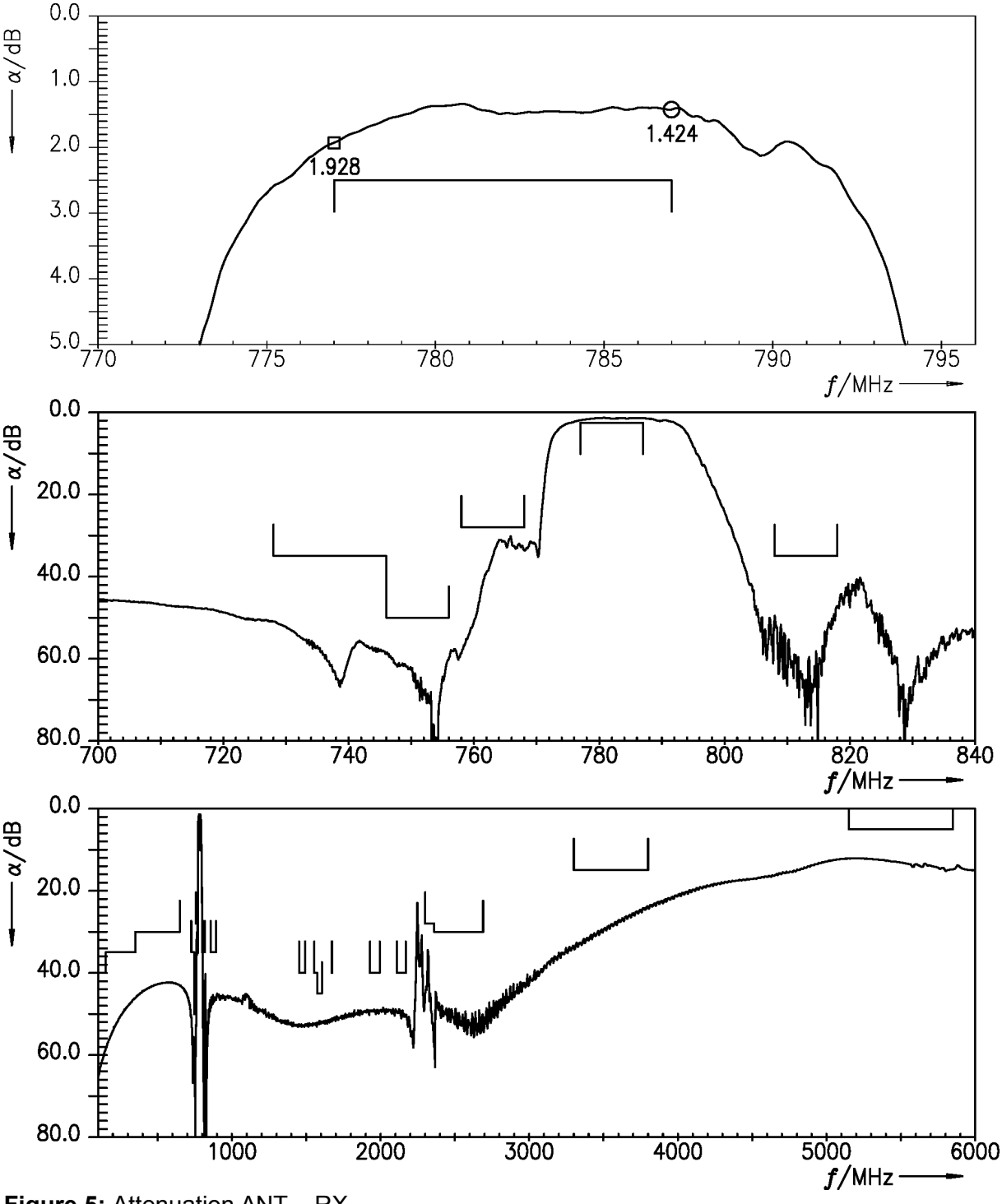

Figure 5: Attenuation ANT – RX.

8.3 TX – RX

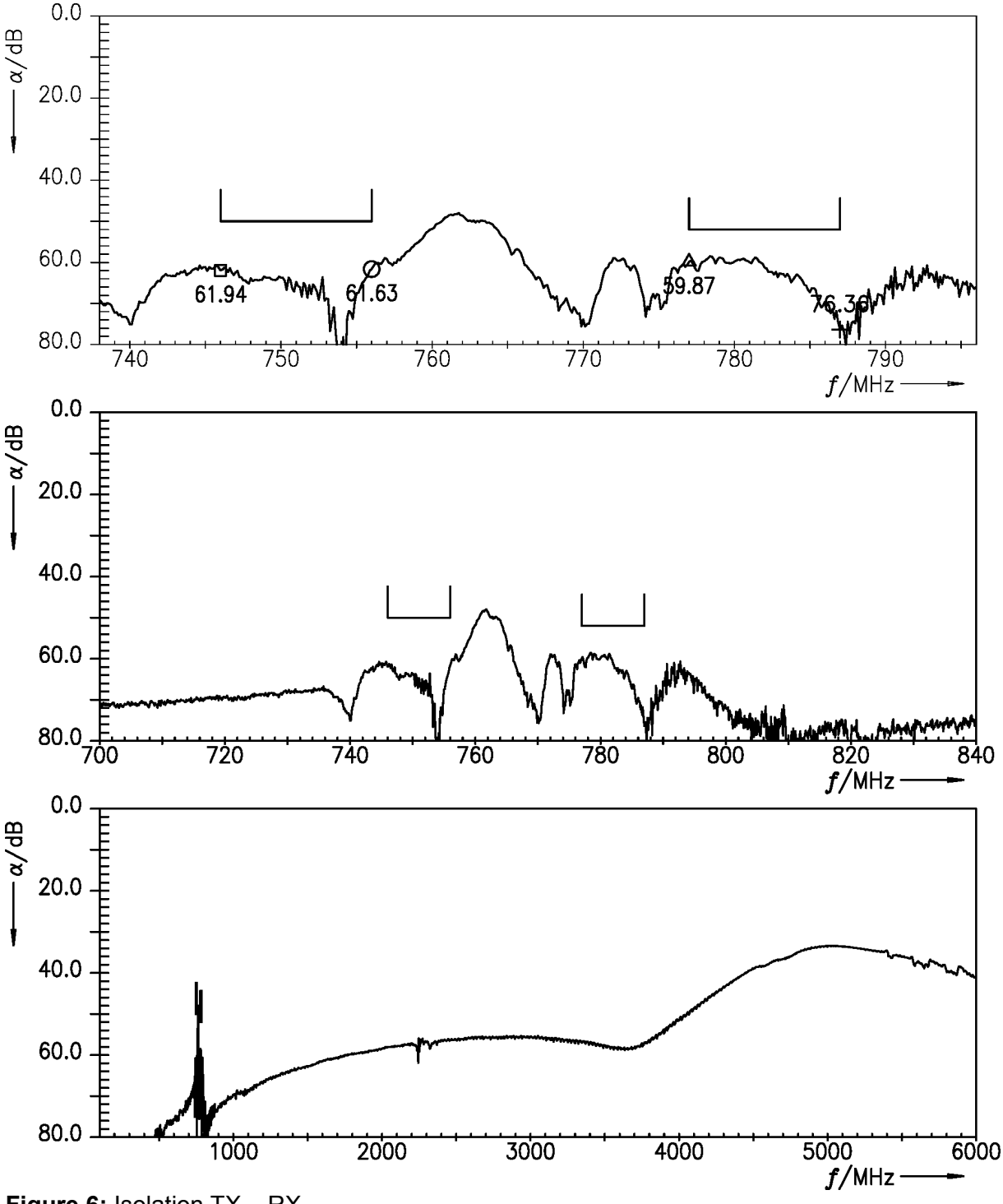

Figure 6: Isolation TX – RX.

9 Reflection coefficients

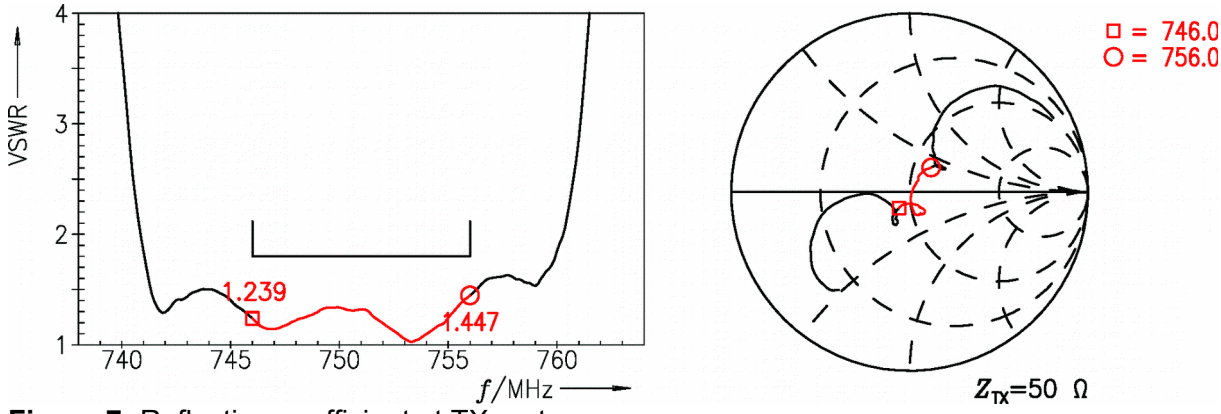

Figure 7: Reflection coefficient at TX port.

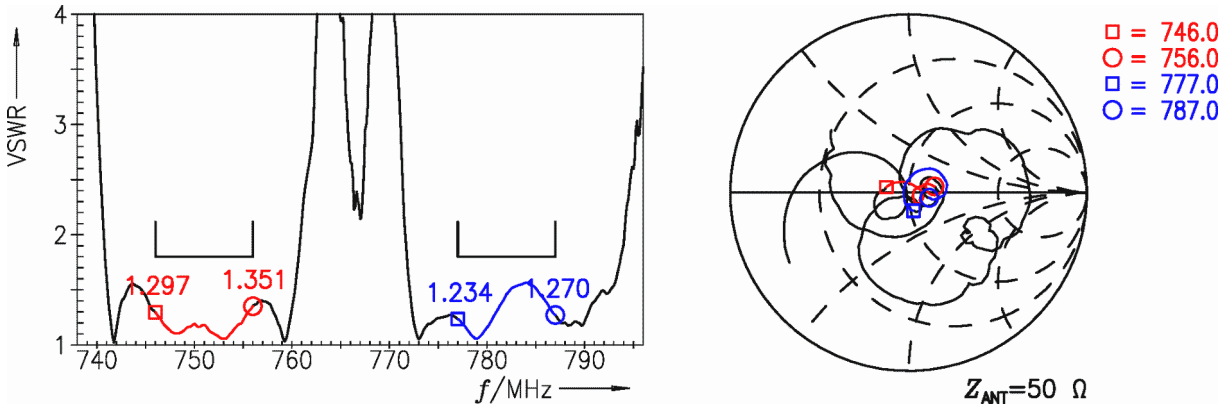

Figure 8: Reflection coefficient at ANT port.

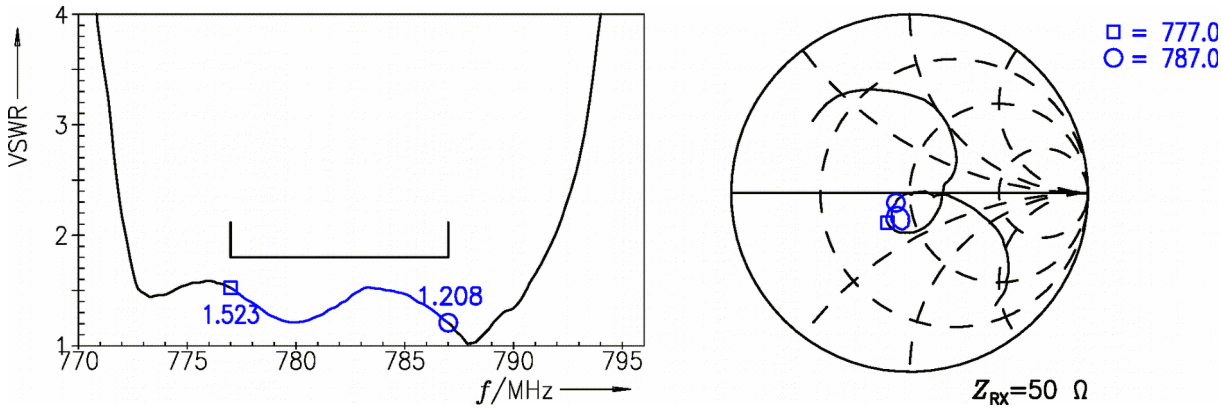

Figure 9: Reflection coefficient at RX port.

10 EVMs

10.1 TX – ANT

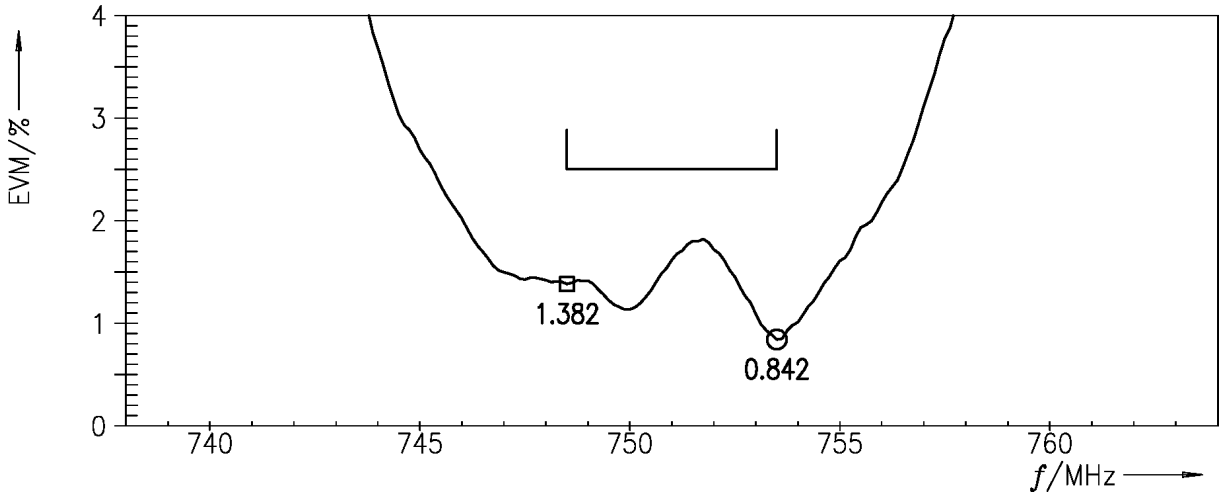

Figure 10: Error vector magnitude TX – ANT.

10.2 ANT – RX

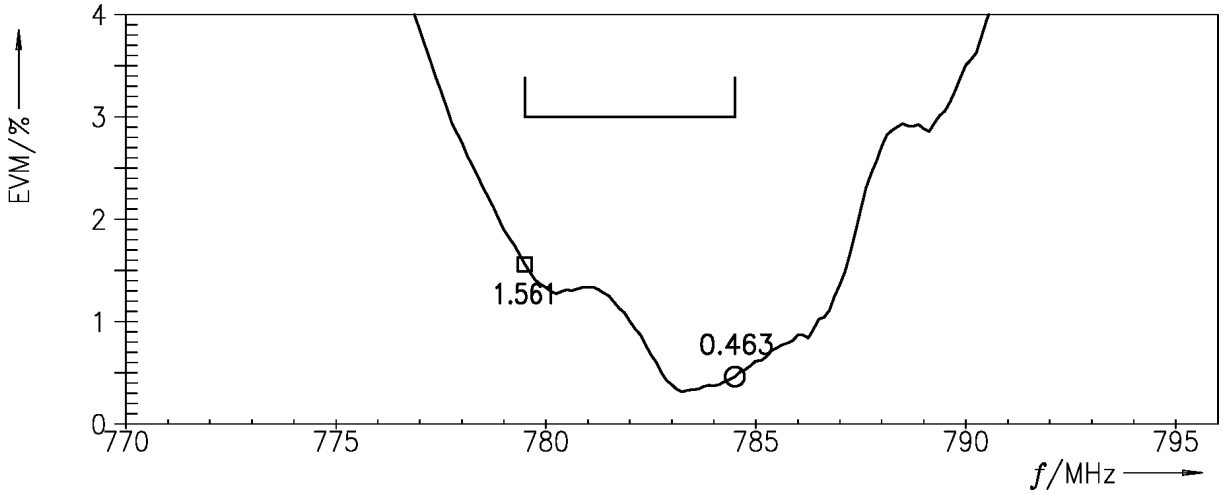

Figure 11: Error vector magnitude ANT – RX.

11 Packing material

11.1 Tape

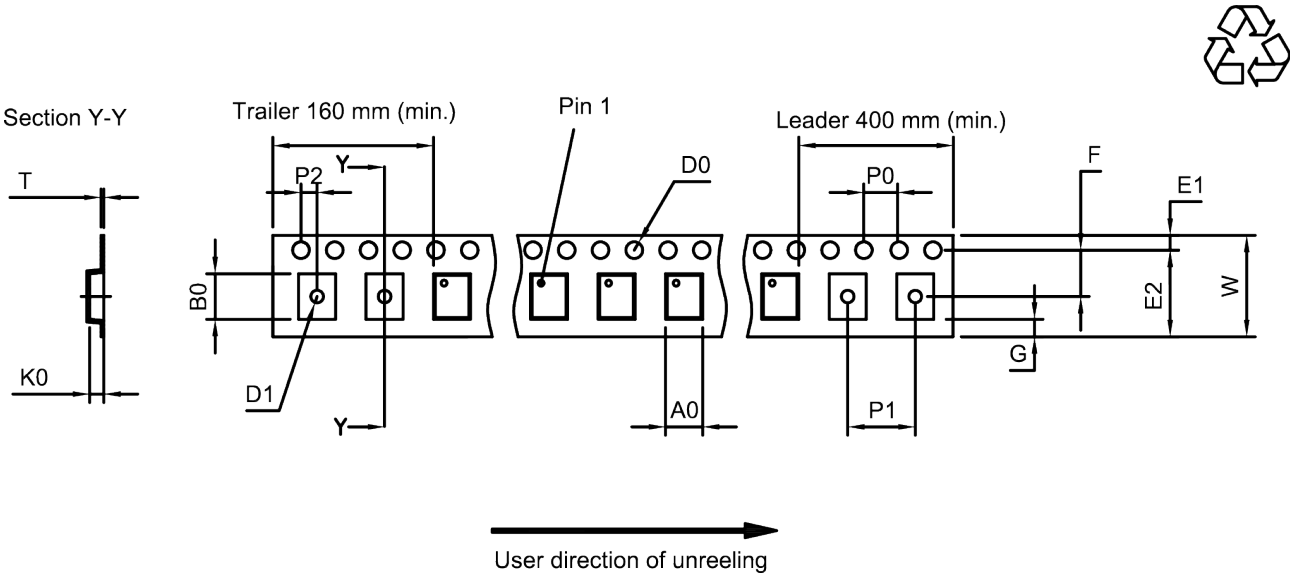

Figure 12: Drawing of tape (first-angle projection) with tape dimensions according to Table 1.

A_0	2.25±0.05 mm
B_0	2.75±0.05 mm
D_0	1.5+0.1/−0 mm
D_1	1.0 mm (min.)
E_1	1.75±0.1 mm

E_2	6.25 mm (min.)
F	3.5±0.05 mm
G	0.75 mm (min.)
K_0	0.6±0.05 mm
P_0	4.0±0.1 mm

P_1	4.0±0.1 mm
P_2	2.0±0.05 mm
T	0.25±0.03 mm
W	8.0+0.3/−0.1 mm

Table 1: Tape dimensions.

11.2 Reel with diameter of 180 mm

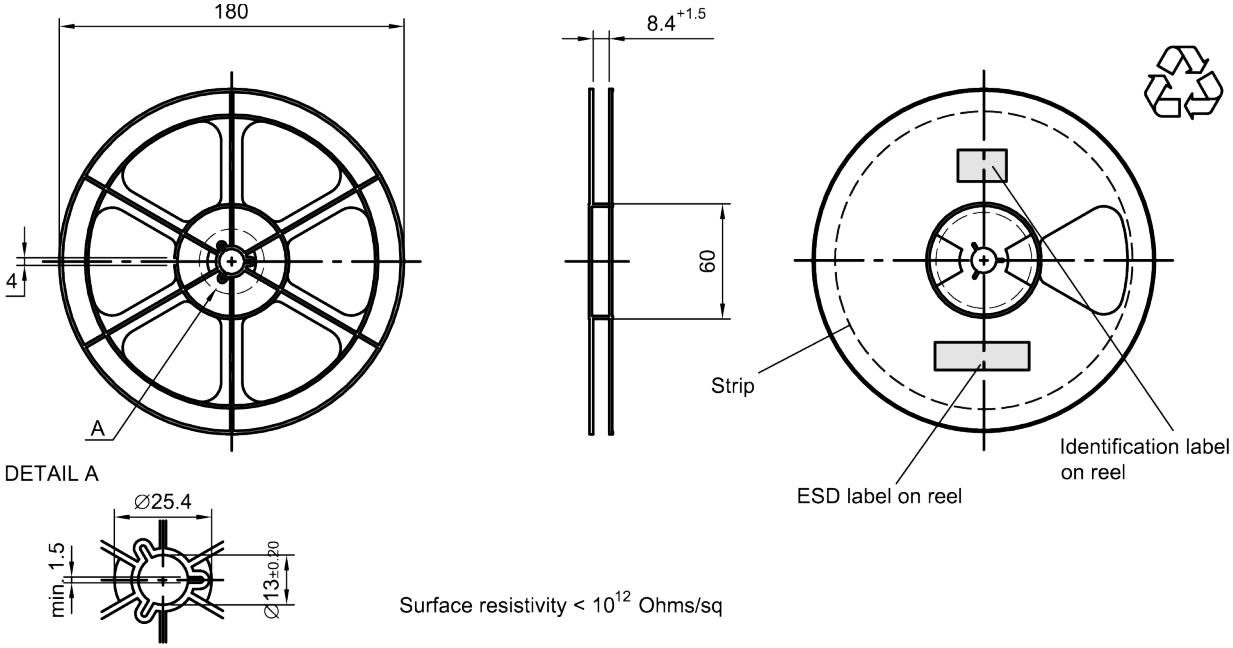

Figure 13: Drawing of reel (first-angle projection) with diameter of 180 mm.

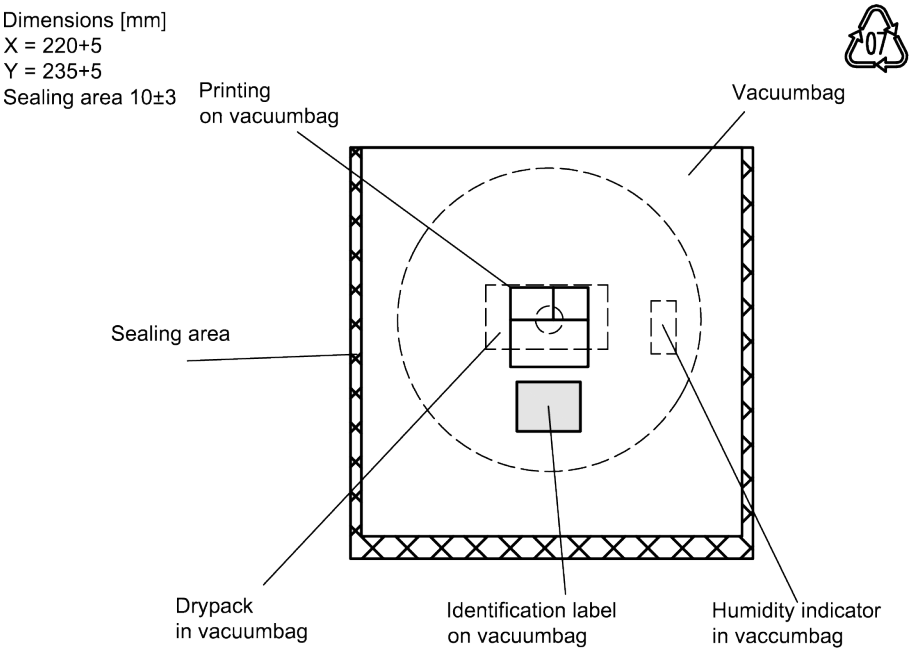

Figure 14: Drawing of moisture barrier bag (MBB) for reel with diameter of 180 mm.

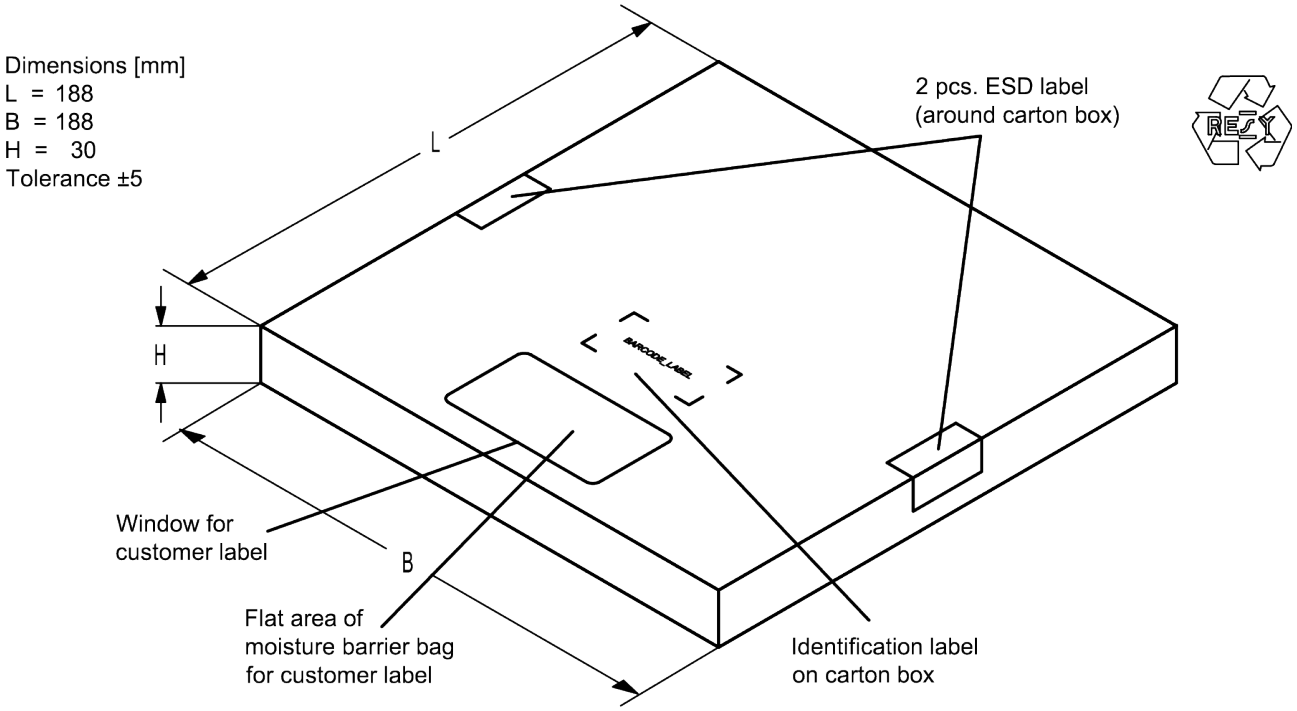

Figure 15: Drawing of folding box for reel with diameter of 180 mm.

11.3 Reel with diameter of 330 mm

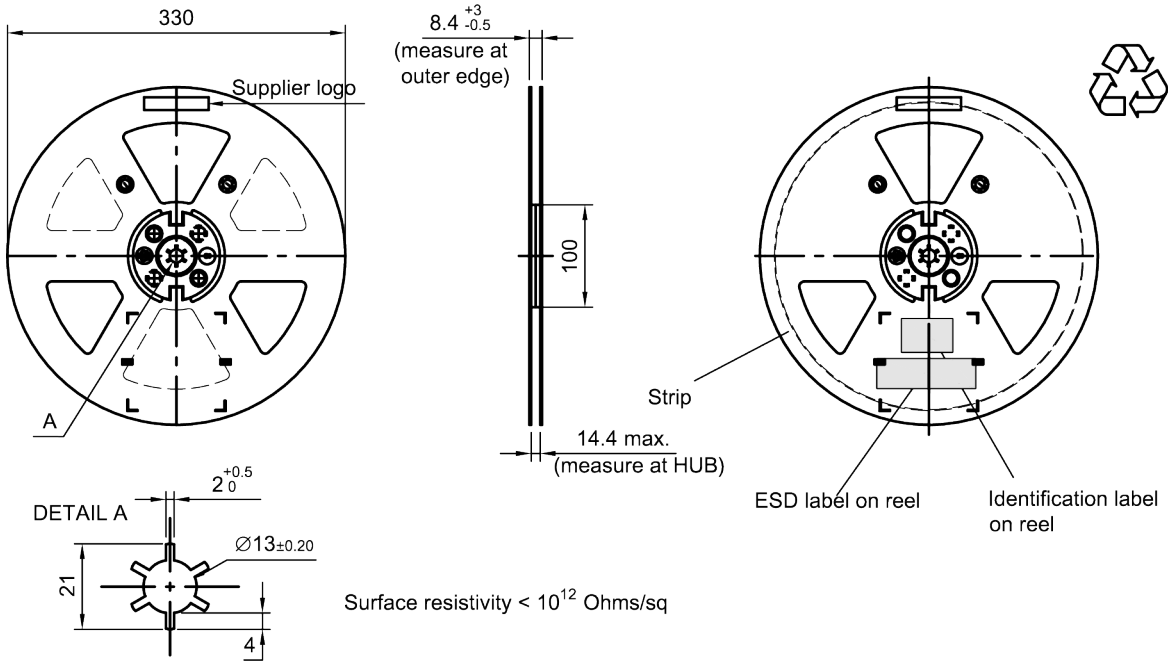

Figure 16: Drawing of reel (first-angle projection) with diameter of 330 mm.

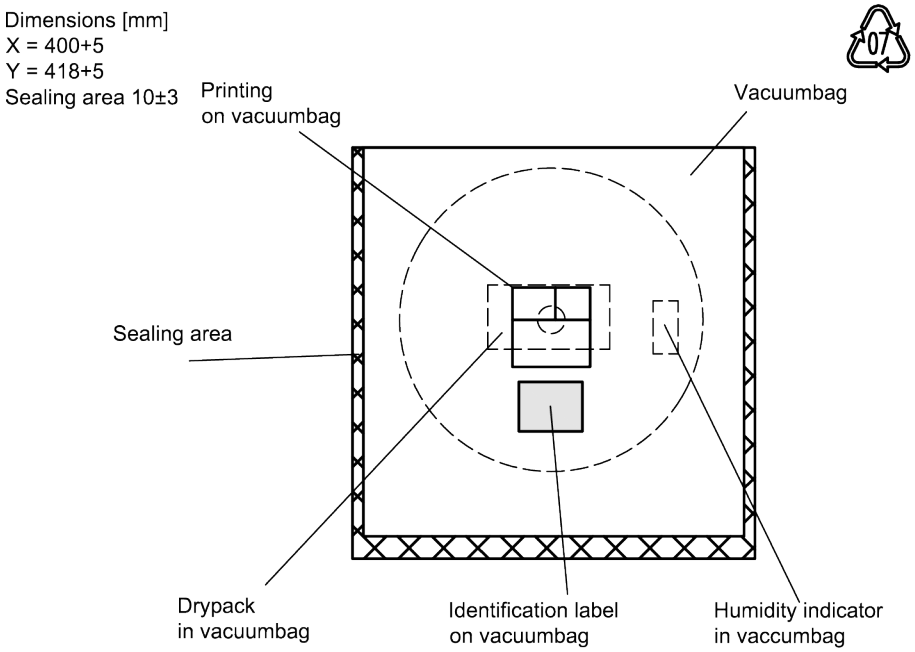

Figure 17: Drawing of moisture barrier bag (MBB) for reel with diameter of 330 mm.

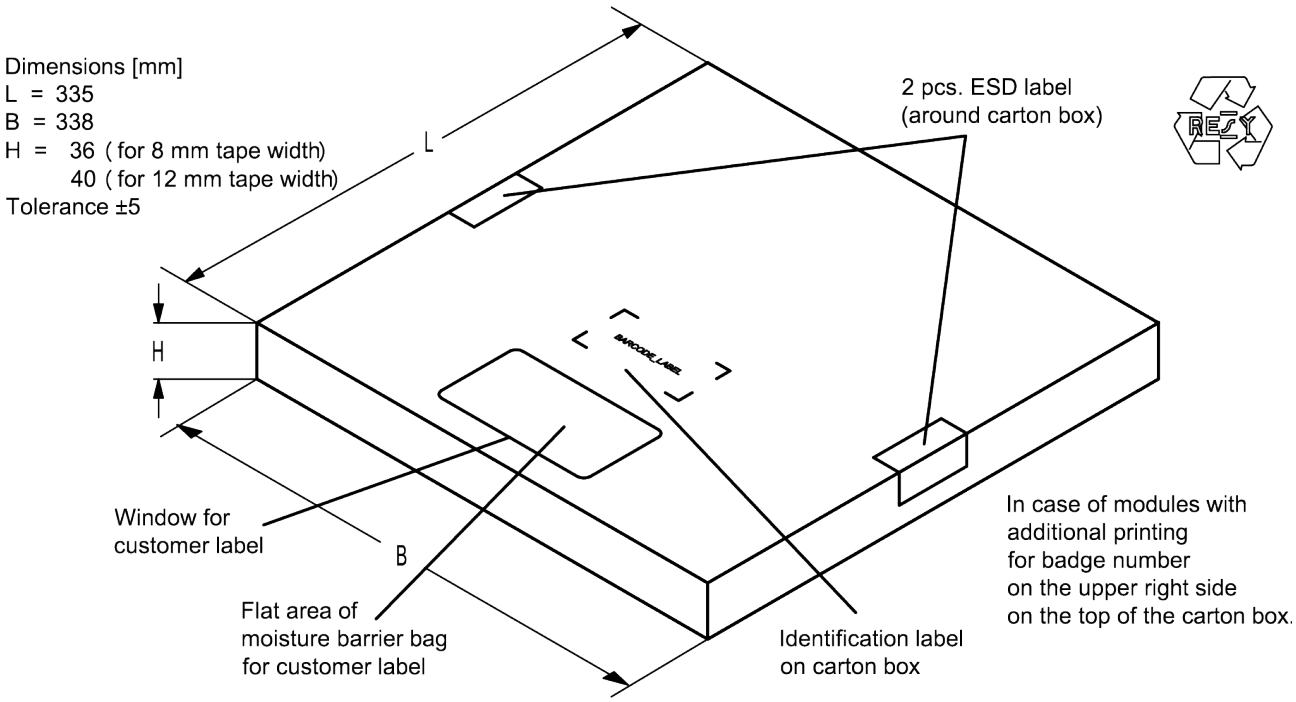

Figure 18: Drawing of folding box for reel with diameter of 330 mm.

12 Marking

Products are marked with product type number and lot number encoded according to Table 2:

- Type number:

  The 4 digit type number of the ordering code, e.g., B3xxxxB**1234**xxxx,
  is encoded by a special BASE32 code into a 3 digit marking.

  Example of decoding type number marking on device in decimal code.
  16J **=>** **1234**
  1 x 32^2 + **6** x 32^1 + **18 (=J)** x 32^0 **=** **1234**
  The BASE32 code for product type B8005 is 7T5.

- Lot number:

  The last 5 digits of the lot number, e.g., **12345**,
  are encoded based on a special BASE47 code into a 3 digit marking.

  Example of decoding lot number marking on device in decimal code.
  5UY **=>** **12345**
  5 x 47^2 + **27 (=U)** x 47^1 + **31 (=Y)** x 47^0 **=** **12345**

Adopted BASE32 code for type number			
Decimal value	Base32 code	Decimal value	Base32 code
0	0	16	G
1	1	17	H
2	2	18	J
3	3	19	K
4	4	20	M
5	5	21	N
6	6	22	P
7	7	23	Q
8	8	24	R
9	9	25	S
10	A	26	T
11	B	27	V
12	C	28	W
13	D	29	X
14	E	30	Y
15	F	31	Z

Adopted BASE47 code for lot number			
Decimal value	Base47 code	Decimal value	Base47 code
0	0	24	R
1	1	25	S
2	2	26	T
3	3	27	U
4	4	28	V
5	5	29	W
6	6	30	X
7	7	31	Y
8	8	32	Z
9	9	33	b
10	A	34	d
11	B	35	f
12	C	36	h
13	D	37	n
14	E	38	r
15	F	39	t
16	G	40	v
17	H	41	\
18	J	42	?
19	K	43	{
20	L	44	}
21	M	45	<
22	N	46	>
23	P		

Table 2: Lists for encoding and decoding of marking.

13 Soldering profile

The recommended soldering process is in accordance with IEC 60068-2-58 – 3rd edit and IPC/JEDEC J-STD-020B.

ramp rate	≤ 3 K/s
preheat	125 °C to 220 °C, 150 s to 210 s, 0.4 K/s to 1.0 K/s
T > 220 °C	30 s to 70 s
T > 230 °C	min. 10 s
T > 245 °C	max. 20 s
T ≥ 255 °C	–
peak temperature T_{peak}	250 °C +0/-5 °C
wetting temperature T_{min}	230 °C +5/-0 °C for 10 s ± 1 s
cooling rate	≤ 3 K/s
soldering temperature T	measured at solder pads

Table 3: Characteristics of recommended soldering profile for lead-free solder (Sn95.5Ag3.8Cu0.7).

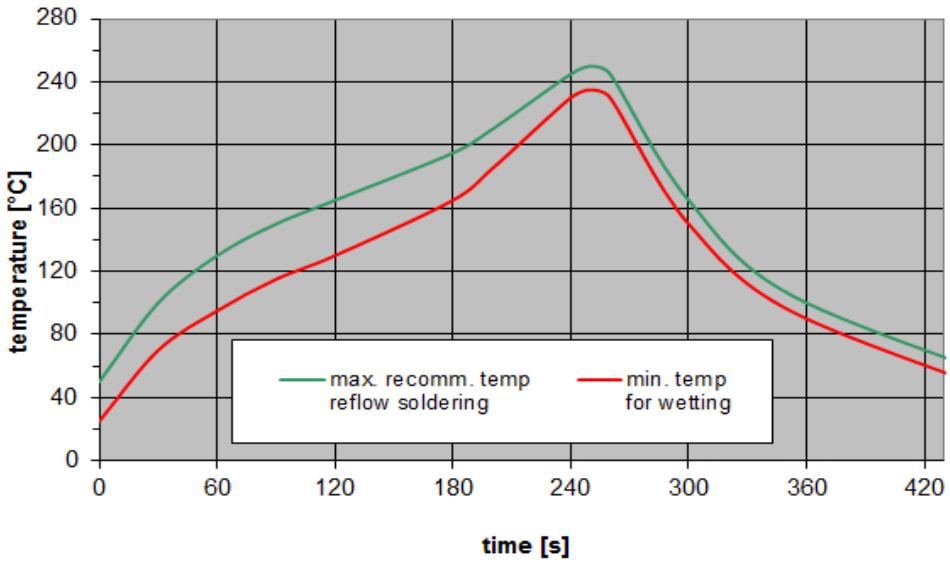

Figure 19: Recommended reflow profile for convection and infrared soldering – lead-free solder.

14 Annotations

14.1 Matching coils

See TDK inductor pdf-catalog http://www.tdk.co.jp/tefe02/coil.htm#aname1 and Data Library for circuit simulation http://www.tdk.co.jp/etvcl/index.htm.

14.2 RoHS compatibility

ROHS-compatible means that products are compatible with the requirements according to Art. 4 (substance restrictions) of Directive 2011/65/EU of the European Parliament and of the Council of June 8th, 2011, on the restriction of the use of certain hazardous substances in electrical and electronic equipment ("Directive") with due regard to the application of exemptions as per Annex III of the Directive in certain cases.

14.3 Scattering parameters (S-parameters)

The pin/port assignment is available in the headers of the S-parameter files. Please contact your local RF360 sales office.

14.4 Ordering codes and packing units

Ordering code	Packing unit
B39781B8005P810	5000 pcs

Table 4: Ordering codes and packing units.

15 Cautions and warnings

15.1 Display of ordering codes for RF360 products

The ordering code for one and the same product can be represented differently in data sheets, data books, other publications and the website of RF360, or in order-related documents such as shipping notes, order confirmations and product labels. The varying representations of the ordering codes are due to different processes employed and do not affect the specifications of the respective products. Detailed information can be found on the Internet under www.rf360jv.com/orderingcodes.

15.2 Material information

Due to technical requirements components may contain dangerous substances. For information on the type in question please also contact one of our sales offices.

For information on recycling of tapes and reels please contact one of our sales offices.

15.3 Moldability

Before using in overmolding environment, please contact your local RF360 sales office.

15.4 Package information

Landing area

The printed circuit board (PCB) land pattern (landing area) shown is based on RF360 internal development and empirical data and illustrated for example purposes, only. As customers' SMD assembly processes may have a plenty of variants and influence factors which are not under control or knowledge of RF360, additional careful process development on customer side is necessary and strongly recommended in order to achieve best soldering results tailored to the particular customer needs.

Dimensions

Unless otherwise specified all dimensions are understood using unit millimeter (mm).

Dimensions do not include burrs.

Projection method

Unless otherwise specified first-angle projection is applied.

Important notes

The following applies to all products named in this publication:

1. Some parts of this publication contain **statements about the suitability of our products for certain areas of application**. These statements are based on our knowledge of typical requirements that are often placed on our products in the areas of application concerned. We nevertheless expressly point out **that such statements cannot be regarded as binding statements about the suitability of our products for a particular customer application.** As a rule, RF360 Europe GmbH and its affiliates are either unfamiliar with individual customer applications or less familiar with them than the customers themselves. For these reasons, it is always ultimately incumbent on the customer to check and decide whether an RF360 product with the properties described in the product specification is suitable for use in a particular customer application.
2. We also point out that **in individual cases, a malfunction of electronic components or failure before the end of their usual service life cannot be completely ruled out in the current state of the art, even if they are operated as specified.** In customer applications requiring a very high level of operational safety and especially in customer applications in which the malfunction or failure of an electronic component could endanger human life or health (e.g. in accident prevention or life-saving systems), it must therefore be ensured by means of suitable design of the customer application or other action taken by the customer (e.g. installation of protective circuitry or redundancy) that no injury or damage is sustained by third parties in the event of malfunction or failure of an electronic component.
3. **The warnings, cautions and product-specific notes must be observed.**
4. In order to satisfy certain technical requirements, **some of the products described in this publication may contain substances subject to restrictions in certain jurisdictions (e.g. because they are classed as hazardous)**. Useful information on this will be found in our Material Data Sheets on the Internet (www.rf360jv.com/material). Should you have any more detailed questions, please contact our sales offices.
5. We constantly strive to improve our products. Consequently, **the products described in this publication may change from time to time**. The same is true of the corresponding product specifications. Please check therefore to what extent product descriptions and specifications contained in this publication are still applicable before or when you place an order. We also **reserve the right to discontinue production and delivery of products**. Consequently, we cannot guarantee that all products named in this publication will always be available.
   The aforementioned does not apply in the case of individual agreements deviating from the foregoing for customer-specific products.

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